



The ST7 Series is a combo connector that simultaneously accepts a micro SD[™] card in a push-push slot, and a GSM11.11 standard compatible Plug-in SIM card.

* microSDTM is a trademark of <u>SD</u> Card <u>A</u>ssociation.

Features

- Combo connector compatible with slide-type GSM11.11 standard Plug-in SIM card, and reverse-mounting push-push structure compatible with the microSD[™] card standardized by the SDA[™]
- ■0.8mm push stroke and 3.3mm card eject length
- Card half lock structure
- Countermeasure to prevent the card from popping out
- ■Card insertion detection structure (D-SW), Normally open: micro SDTM and SIM card
- ■Shield feature is secured by 4 ground connection points
- ■Slim design with 3.2mm height, 17.8mm width, and 20.5mm depth (depth including card: 27.25mm)
- Supply for automatic mounting in embossed tape (Compatible with second reflow)

General Specifications

- ■No. of contacts :14 pos.+2pos. (D-SW) ■Rated current: 0.5A/ per pin
- Contact resistance: 100m ohm max.
- Dielectric withstanding voltage :
- AC500Vr.m.s. per minute
- Operating temperature:
 - -25 Deg. C to +85 Deg. C
- Storage temperature:
 - -10 Deg. C to +60 Deg. C

- Rated voltage: 10V/ per pin
- ■Insulation resistance: 1000M ohm min.
- ■Lifetime: Plug-in SIM: 5,000 times micro SD[™]: 10.000 times
- ■Temperature rise: 30 Deg. C rise max.

Materials and Finishes

Components	Material /Finish	
Signal contact	Copper Alloy/	
(microSD, SIM	Contact: 0.5um min. Au plating over Ni	
in common)	Terminal: Au flash plating over Ni	
Housing	Synthetic resin/ No (UL94V-0)	
Cover frame	Stainless steel/ terminal area: Au flash plating over Ni	
Eject bar	Synthetic resin/ No (UL94V-0)	
Spring	Stainless steel/ None	
D-SW contact	Plating: Compliant to finish of signal contact	
Lock	Stainless steel/ None	
Cam follower	Stainless steel/ None	



MB-0188-1



TABLE1 Circuit [Detection Switch]

	WITHOUT CARD	CARD MATED
microSD	7-0 0-8 VGND	7 8 VGND
SIM	(12)	(1 2) V G N D



Applicable board dimensions (for reference)

Note) An embossed tape reel contains 800 pcs.

Please contact us for details on embossed tape specifications.

Japan Aviation Electronics Industry, Limited

Product Marketing Division Aobadai Building, 3-1-19, Aobadai, Meguro-ku, Tokyo 153-8539 Phone: +81-3-3780-2787 FAX: +81-3-3780-2946 **Notice:** Products shown in this leaflet are made for the applications listed below. However, if the above-mentioned products are to be used in aerospace devices, marine cable-connection devices, atomic power control systems, medical equipment for life-support systems, or any other specific application requiring extremely high reliability, please contact JAE for further information. Recommended applications: computers, office machines, measuring devices, telecommunication devices (terminals, mobile devices), AV devices, household applications, FA devices, etc.

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